

March 2015



# FDD3670

## 100V N-Channel PowerTrench<sup>®</sup> MOSFET

### **General Description**

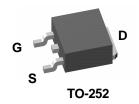
This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers.

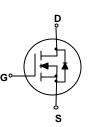
These MOSFETs f eature faster switching and lower gate charge than other MOSFETs with comparable  $R_{DS(ON)}$  specifications.

The result is a MOSFET that is easy and safer to drive (even at very high frequencies), and DC/DC power supply designs with higher overall efficiency.

### Features

- 34 A, 100 V.  $R_{DS(ON)} = 32 \text{ m}\Omega @ V_{GS} = 10 \text{ V}$  $R_{DS(ON)} = 35 \text{ m}\Omega @ V_{GS} = 6 \text{ V}$
- Low gate charge (57 nC typical)
- Fast switching speed
- + High performance trench technology for extremely low  $R_{\text{DS}(\text{ON})}$
- High power and current handling capability





### Absolute Maximum Ratings T<sub>A</sub>=25°C unless otherwise noted

Symbol	Parameter	Ratings		
V <sub>DSS</sub>	Drain-Source Voltage		100	V
V <sub>GSS</sub>	Gate-Source Voltage		±20	V
l <sub>D</sub>	Drain Current – Continuous	(Note 1)	34	A
	Drain Current – Pulsed	(Note 3)	100	
PD	Maximum Power Dissipation @ T <sub>c</sub> = 25°C	(Note 1)	83	W
	@ T <sub>A</sub> = 25°C	(Note 1a)	3.8	
	@ T <sub>A</sub> = 25°C	(Note 1b)	1.6	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature	e Range	–55 to +175	°C

## **Thermal Characteristics**

R <sub>0JC</sub>	Thermal Resistance, Junction-to-Case	(Note 1)	1.8	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1b)	96	°C/W

## Package Marking and Ordering Information

FDD3670 FDD3670 13" 16mm 2500 ur	Device Marking	Device	Reel Size	Tape width	Quantity
	FDD3670	FDD3670	13"	16mm	2500 units

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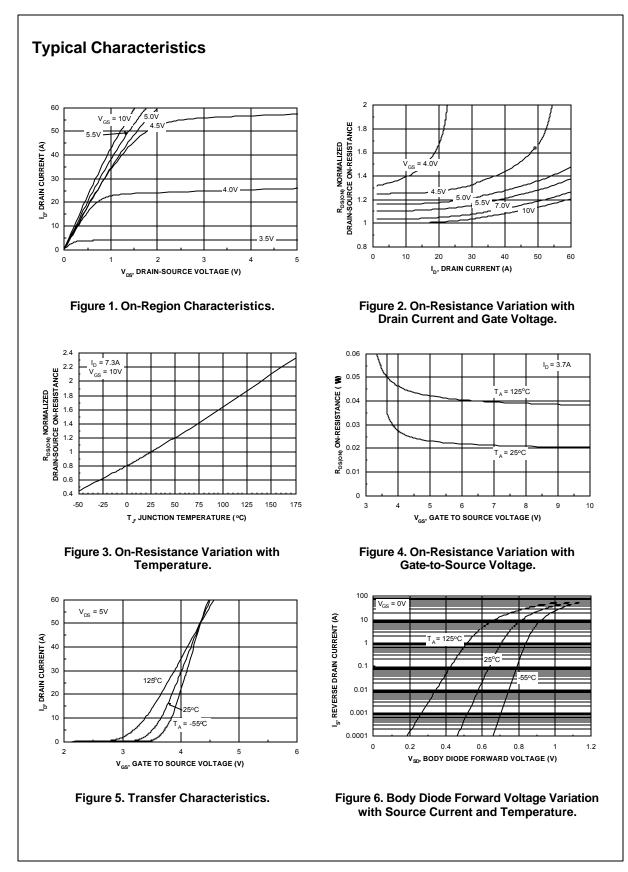
FDD3670

	Parameter	Test Conditions	Min	Тур	Max	Units
Drain-So	ource Avalanche Ratings (Note	2)				
W <sub>DSS</sub>	Single Pulse Drain-Source	$V_{DD} = 50 \text{ V}, \qquad I_D = 7.3 \text{ A}$			360	mJ
<b>I</b> AR	Avalanche Energy Maximum Drain-Source Avalanche				7.3	A
AR	Current				7.0	А
Off Char	acteristics					
BV <sub>DSS</sub>	Drain–Source Breakdown Voltage	V <sub>GS</sub> = 0 V, Ι <sub>D</sub> = 250 μA	100			V
<u>ΔBVdss</u> ΔTj	Breakdown Voltage Temperature Coefficient	$I_D$ = 250 µA, Referenced to 25°C		92		mV/ºC
DSS	Zero Gate Voltage Drain Current	$V_{DS} = 80 V, V_{GS} = 0 V$			10	μA
GSSF	Gate–Body Leakage, Forward	$V_{GS} = 20 V, V_{DS} = 0 V$			100	nA
GSSR	Gate–Body Leakage, Reverse	$V_{GS} = -20 V$ , $V_{DS} = 0 V$			-100	nA
On Char	acteristics (Note 2)		•	•	•	•
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2	2.5	4	V
ΔV <sub>GS(th)</sub> ΔT <sub>J</sub>	Gate Threshold Voltage Temperature Coefficient	$l_{\rm D}$ = 250 µA, Referenced to 25°C		-7.2		mV/°0
R <sub>DS(on)</sub>	Static Drain–Source	$V_{GS}$ = 10 V, $I_D$ = 7.3 A		22	32	mΩ
	On–Resistance	$V_{GS} = 10 \text{ V}, \text{ I}_D = 7.3 \text{ A}, \text{ T}_J = 125^{\circ}\text{C}$ $V_{CS} = 6 \text{ V}$ $\text{I}_D = 7.0 \text{ A}$		39 24	56 35	
D(on)	On–State Drain Current	$V_{GS} = 6 V$ , $I_D = 7.0 A$ $V_{GS} = 10 V$ , $V_{DS} = 5 V$	25			Α
]FS	Forward Transconductance	$V_{DS} = 5 V$ , $I_D = 7.3 A$	15	31		S
-	Characteristics	I	1	1	1	1
C <sub>iss</sub>	Input Capacitance	$V_{DS} = 50 V$ , $V_{GS} = 0 V$ ,		2490		pF
<u>^</u>	Output Capacitance	f = 1.0 MHz		265		pF
oss				80		pF
	Reverse Transfer Capacitance					
C <sub>rss</sub>				1	l	
C <sub>rss</sub> Switchin	Reverse Transfer Capacitance           og Characteristics         (Note 2)           Turn-On Delay Time	Vpp = 50 V. h = 1 A.		16	26	ns
Crss Switchin	ng Characteristics (Note 2)	$V_{DD} = 50 V$ , $I_D = 1 A$ , $V_{GS} = 10 V$ , $R_{GEN} = 6 \Omega$		16 10	26 18	ns ns
C <sub>rss</sub> Switchin I <sub>d(on)</sub> ir	ng Characteristics (Note 2) Turn–On Delay Time			-	-	-
Crss Switchin td(on) tr td(off)	<b>g Characteristics</b> (Note 2) Turn–On Delay Time Turn–On Rise Time			10	18	ns
Crss Switchin id(on) ir id(off) if	<b>g Characteristics</b> (Note 2) Turn–On Delay Time Turn–On Rise Time Turn–Off Delay Time			10 56	18 84	ns ns
Crss <b>Switchin</b> td(on) tr td(off) tr Qg	<b>g Characteristics</b> (Note 2) Turn–On Delay Time Turn–On Rise Time Turn–Off Delay Time Turn–Off Fall Time	$V_{GS}$ = 10 V, $R_{GEN}$ = 6 $\Omega$		10 56 25	18 84 40	ns ns ns
Coss Crss Switchin td(on) tr td(off) tf Qg Qgs Qgd	g Characteristics       (Note 2)         Turn-On Delay Time         Turn-On Rise Time         Turn-Off Delay Time         Turn-Off Fall Time         Total Gate Charge	$V_{GS}$ = 10 V, $R_{GEN}$ = 6 $\Omega$ $V_{DS}$ = 50 V, $I_D$ = 7.3 A,		10 56 25 57	18 84 40	ns ns ns nC
Crss Switchin td(on) tr td(off) tr Qg Qgs Qgs Qgd	g Characteristics (Note 2) Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge	$V_{GS} = 10 \text{ V},$ $R_{GEN} = 6 \Omega$ $V_{DS} = 50 \text{ V},$ $I_D = 7.3 \text{ A},$ $V_{GS} = 10 \text{ V}$		10 56 25 57 11	18 84 40	ns ns ns nC nC
Crss Switchin td(on) tr td(off) tr Qg Qgs Qgs Qgd	g Characteristics (Note 2) Turn–On Delay Time Turn–On Rise Time Turn–Off Delay Time Turn–Off Fall Time Total Gate Charge Gate–Source Charge	$V_{GS} = 10 \text{ V},  R_{GEN} = 6 \Omega$ $V_{DS} = 50 \text{ V},  I_D = 7.3 \text{ A},$ $V_{GS} = 10 \text{ V}$ and Maximum Ratings		10 56 25 57 11	18 84 40	ns ns ns nC nC

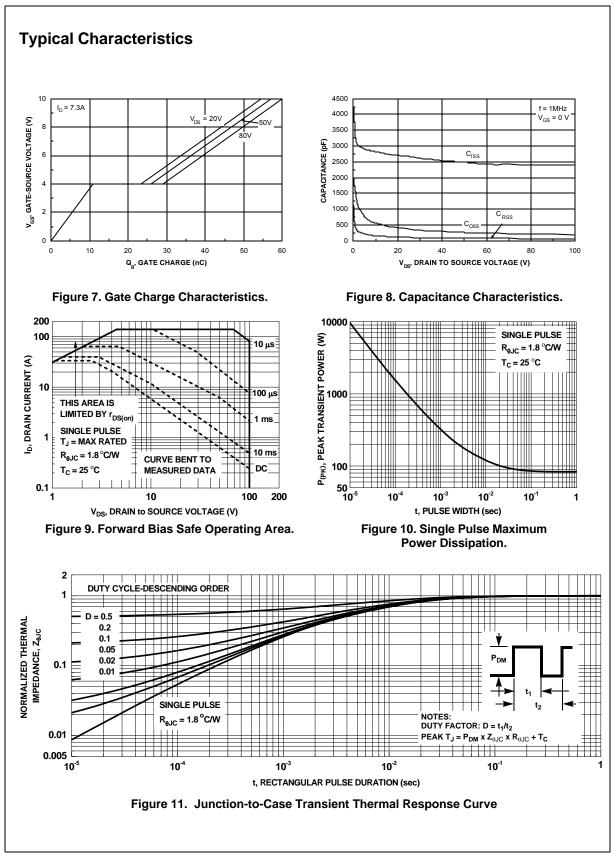
Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width < 300 $\mu$ s, Duty Cycle < 2.0%

3. Pulse Id refers to Figure.9 Forward Bias Safe Operation Area.



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FDD3670 Rev.1.5





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